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FDMD8240LET40 Dual N-Channel Power Trench[®] MOSFET

40 V, 103 A, 2.6 mΩ

Features

- Extended TJ Rating to 175 °C
- Max $r_{DS(on)}$ = 2.6 m Ω at V_{GS} = 10 V, I_D = 23 A
- Max r_{DS(on)} = 3.95 mΩ at V_{GS} = 4.5 V, I_D = 19 A
- Ideal for Flexible Layout in Primary Side of Bridge Topology
- 100% UIL Tested
- Kelvin High Side MOSFET Drive Pin-out Capability
- Termination is Lead-free and RoHS Compliant

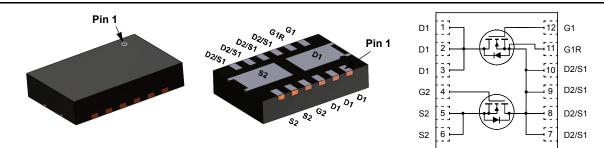


General Description

This device includes two 40V N-Channel MOSFETs in a dual Power (3.3 mm X 5 mm) package. HS source and LS Drain are internally connected for half/full bridge, low source inductance package, low $r_{DS(on)}/Qg$ FOM silicon.

Applications

- Synchronous Buck : Primary Switch of Half / Full Bridge Converter for Telecom
- Motor Bridge : Primary Switch of Half / Full bridge Converter for BLDC Motor
- MV POL : Synchronous Buck Switch



Power 3.3 x 5

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted.

Symbol	Param	eter		Ratings	Units	
V _{DS}	Drain to Source Voltage			40	V	
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T _C = 25 °C	(Note 5)	103		
	-Continuous	T _C = 100 °C	(Note 5)	73	•	
I _D	-Continuous	T _A = 25 °C	(Note 1a)	24	Α	
	-Pulsed		(Note 4)	489		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	216	mJ	
D	Power Dissipation	T _C = 25 °C		50	14/	
P _D	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5	W	
T _J , T _{STG}	Operating and Storage Junction Temperation	ature Range		-55 to +175	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	3.0	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a	a) 60	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
8240LT	FDMD8240LET40	Power 3.3 x 5	13 "	12 mm	3000 units

1

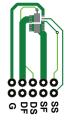
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Chara	octeristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	40			V
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		23		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 32 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±20 V, V _{DS} = 0 V			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	1.0	2.0	3.0	V
$\Delta V_{GS(th)}$ ΔT_J	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		-6		mV/°C
0	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 23 A		2.0	2.6	
r _{DS(on)}		V _{GS} = 4.5 V, I _D = 19 A	3.2 3		3.95	i mΩ
()		V_{GS} = 10 V, I _D = 23 A, T _J = 150 °C		3.3	4.3	1
9 _{FS}	Forward Transconductance	V _{DD} = 5 V, I _D = 23 A		107		S
C _{iss}	Characteristics Input Capacitance Output Capacitance	V _{DS} = 20 V, V _{GS} = 0 V		3020	4230	pF
Dvnamic	Characteristics					
C _{iss} C _{oss}	Input Capacitance Output Capacitance	V _{DS} = 20 V, V _{GS} = 0 V f = 1 MHz		876	1230	pF
C _{iss} C _{oss} C _{rss}	Input Capacitance Output Capacitance Reverse Transfer Capacitance			876 33	1230 52	
C _{iss} C _{oss} C _{rss}	Input Capacitance Output Capacitance		0.1	876	1230	pF
C _{iss} C _{oss} C _{rss} R _g	Input Capacitance Output Capacitance Reverse Transfer Capacitance		0.1	876 33	1230 52	pF pF
C _{iss} C _{oss} C _{rss} R _g Switching	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance		0.1	876 33	1230 52	pF pF
C _{iss} C _{oss} C _{rss} Rg Switching	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics	f = 1 MHz	0.1	876 33 2.8	1230 52 6	pF pF Ω
C _{iss} C _{oss} C _{rss} Rg Switching t _{d(on)}	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance 9 Characteristics Turn-On Delay Time		0.1	876 33 2.8 12	1230 52 6 22	pF pF Ω ns
C_{iss} C_{oss} C_{rss} Switching $t_{d(on)}$ t_r $t_{d(off)}$	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time	f = 1 MHz	0.1	876 33 2.8 12 8	1230 52 6 22 16	pF pF Ω ns ns
C_{iss} C_{oss} C_{rss} Switching $t_{d(on)}$ t_r $t_{d(off)}$ t_f	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time	$f = 1 \text{ MHz}$ $V_{DD} = 20 \text{ V}, I_D = 23 \text{ A}$ $V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$	0.1	876 33 2.8 12 8 36	1230 52 6 22 16 58	pF pF Ω ns ns
C_{iss} C_{oss} C_{rss} Switching $t_{d(on)}$ t_r $t_{d(off)}$ t_f	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	f = 1 MHz $V_{DD} = 20 \text{ V}, I_D = 23 \text{ A}$ $V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$	0.1	876 33 2.8 12 8 36 9	1230 52 6 22 16 58 18	pF pF Ω ns ns ns ns
C _{iss} C _{oss} C _{rss} Switching Switching t _{d(on)} t _r t _{d(off)} t _f Q _{g(TOT)}	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge	$f = 1 \text{ MHz}$ $V_{DD} = 20 \text{ V}, I_D = 23 \text{ A}$ $V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$	0.1	876 33 2.8 12 8 36 9 40	1230 52 6 22 16 58 18 56	pF pF Ω ns ns ns nC nC
C _{iss} C _{oss} C _{rss} Switching t _{d(on)} t _r t _{d(off)} t _f Q _{g(TOT)} Q _{gs}	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge	$f = 1 \text{ MHz}$ $V_{DD} = 20 \text{ V}, \text{ I}_{D} = 23 \text{ A}$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $V_{DD} = 20 \text{ V}$	0.1	876 33 2.8 12 8 36 9 40 21	1230 52 6 22 16 58 18 56	pF pF Ω ns ns ns nC nC
$\begin{array}{c} C_{iss} \\ \hline C_{oss} \\ \hline C_{rss} \\ \hline R_g \\ \hline \textbf{Switching} \\ \hline \textbf{Switching} \\ \hline \textbf{t}_{d(on)} \\ \hline \textbf{t}_r \\ \hline \textbf{t}_{d(off)} \\ \hline \textbf{t}_f \\ \hline \textbf{Q}_{g(TOT)} \\ \hline \textbf{Q}_{gs} \\ \hline \textbf{Q}_{gd} \\ \hline \end{array}$	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance g Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge	$f = 1 \text{ MHz}$ $V_{DD} = 20 \text{ V}, \text{ I}_{D} = 23 \text{ A}$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $V_{DD} = 20 \text{ V}$	0.1	876 33 2.8 12 8 36 9 40 21 9	1230 52 6 22 16 58 18 56	pF pF Ω ns ns ns nC nC
$\begin{array}{c} C_{iss} \\ C_{oss} \\ \hline \\ C_{rss} \\ \hline \\ R_g \\ \hline \\ Switching \\ \hline \\ Switching \\ \hline \\ t_{d(on)} \\ t_r \\ t_r \\ \hline \\ t_{d(off)} \\ t_r \\ \hline \\ Q_{g(TOT)} \\ \hline \\ Q_{gs} \\ \hline \\ Q_{gd} \\ \hline \\ \hline \\ Drain-Sol \\ \hline \end{array}$	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge Urce Diode Characteristics	$f = 1 \text{ MHz}$ $V_{DD} = 20 \text{ V}, I_D = 23 \text{ A}$ $V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $I_D = 20 \text{ V}$ $I_D = 23 \text{ A}$	0.1	876 33 2.8 12 8 36 9 40 21 9 5	1230 52 6 22 16 58 18 56 30	pF pF Ω ns ns ns nc nC nC
$\begin{array}{c} C_{iss} \\ C_{oss} \\ C_{rss} \\ R_{g} \\ \hline \\ \textbf{Switching} \\ \hline \\ \textbf{Switching} \\ \hline \\ \textbf{t}_{d(on)} \\ t_{f} \\ t_{f} \\ \hline \\ \textbf{Q}_{g(TOT)} \\ \hline \\ \textbf{Q}_{gg} \\ \hline \\ \textbf{Q}_{gd} \\ \hline \\ \hline \\ \textbf{Drain-Sol} \end{array}$	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge	$f = 1 \text{ MHz}$ $V_{DD} = 20 \text{ V}, \text{ I}_{D} = 23 \text{ A}$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{DD} = 20 \text{ V}$ $I_{D} = 23 \text{ A}$ $V_{GS} = 0 \text{ V}, \text{ I}_{S} = 23 \text{ A}$ (Note 2)	0.1	876 33 2.8 12 8 36 9 40 21 9	1230 52 6 22 16 58 18 56	pF pF Ω ns ns ns nc nC nC nC
$\begin{array}{c} C_{iss} \\ \hline C_{oss} \\ \hline C_{rss} \\ \hline R_g \\ \hline \textbf{Switching} \\ \hline \textbf{Switching} \\ \hline \textbf{t}_{d(on)} \\ \hline \textbf{t}_r \\ \hline \textbf{t}_{d(off)} \\ \hline \textbf{t}_f \\ \hline \textbf{Q}_{g(TOT)} \\ \hline \textbf{Q}_{gs} \\ \hline \textbf{Q}_{gd} \\ \hline \end{array}$	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge Urce Diode Characteristics	$f = 1 \text{ MHz}$ $V_{DD} = 20 \text{ V}, \text{ I}_{D} = 23 \text{ A}$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{DD} = 20 \text{ V}$ $I_{D} = 23 \text{ A}$ $V_{GS} = 0 \text{ V}, \text{ I}_{S} = 23 \text{ A}$ (Note 2)	0.1	876 33 2.8 12 8 36 9 40 21 9 5 5	1230 52 6 22 16 58 18 56 30	pF pF Ω ns ns ns nc nC nC nC

NOTES:

1. $R_{\theta JA}$ is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



a. 60 °C/W when mounted on a 1 in² pad of 2 oz copper



b. 130 °C/W when mounted on a minimum pad of 2 oz copper

2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0 %.

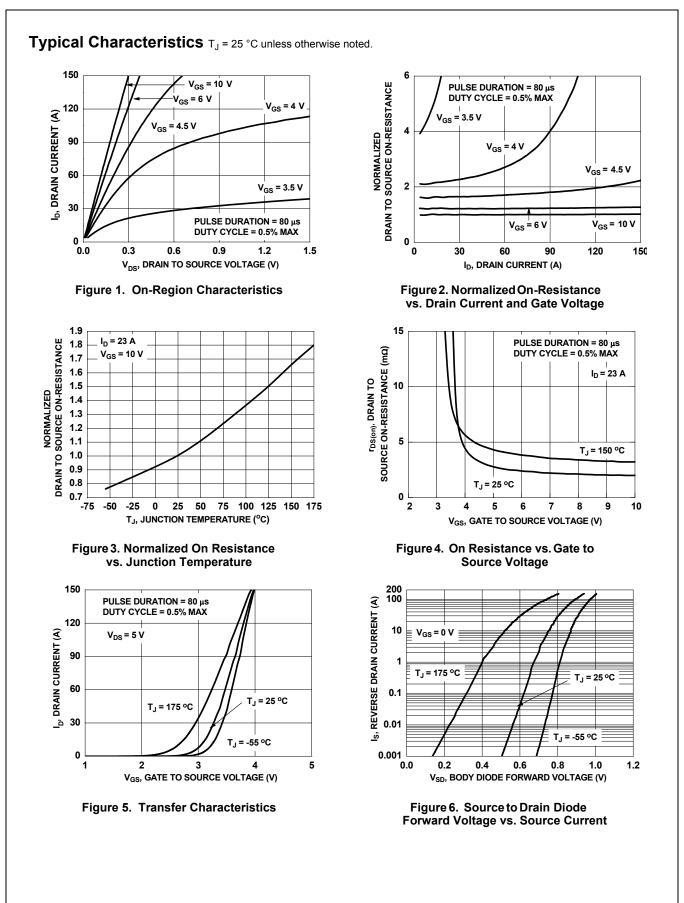
3. E_{AS} of 216 mJ is based on starting T_J = 25 °C, L = 3 mH, I_{AS} = 12 A, V_{DD} = 40 V, V_{GS} = 10 V. 100% tested at L = 0.1 mH, I_{AS} = 37 A.

4. Pulsed Id please refer to Fig 11 SOA graph for more details.

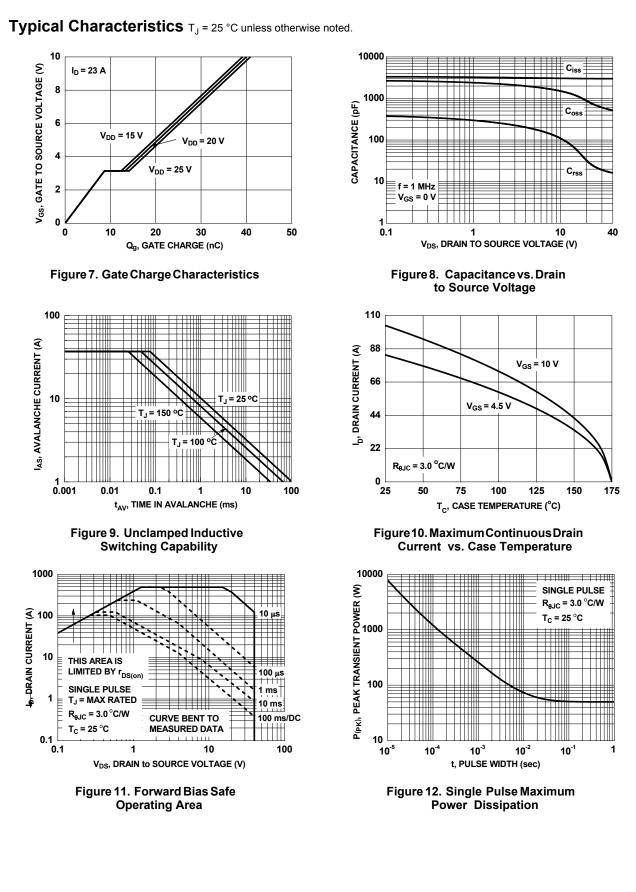
5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

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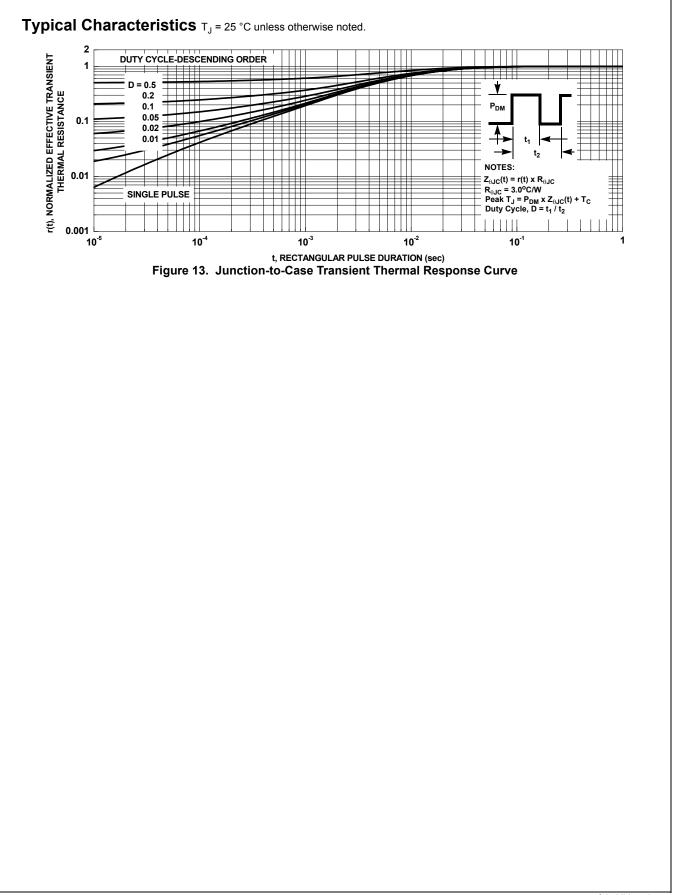


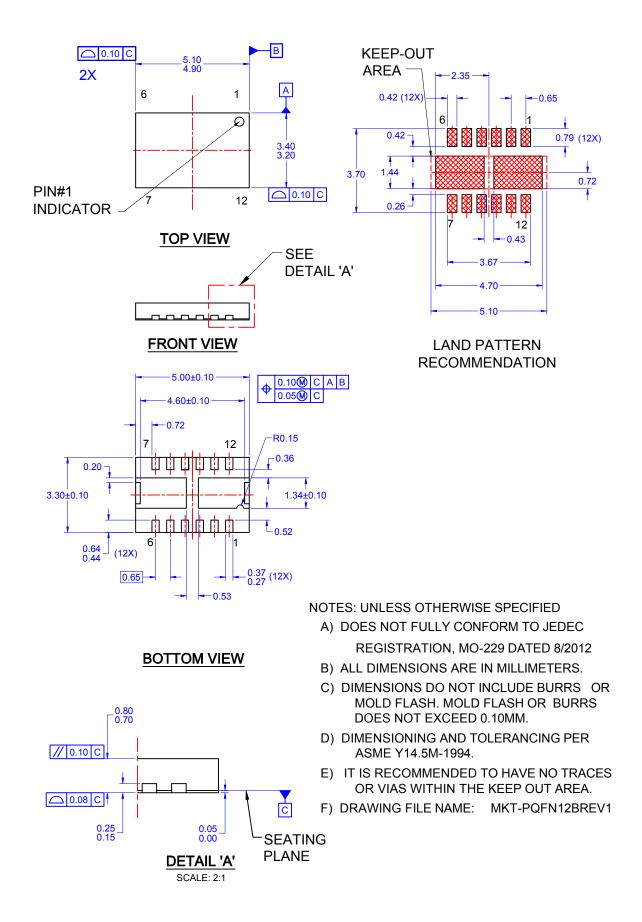
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